

Day : Friday
Date: 2/11/2005


PALM INTRANET

Time: 14:28:28

Inventor Name Search Result

Your Search was:

Last Name = YEAGER

First Name = GARY

Application#	Patent#	Status	Date Filed	Title	Inventor Name 51
<u>60319872</u>	Not Issued	159	01/16/2003	THERMOSET COMPOSITE COMPOSITION, METHOD, AND ARTICLE	YEAGER, GARY WILLIAM
<u>60319805</u>	Not Issued	159	12/20/2002	THERMOSET COMPOSITE COMPOSITION, METHOD, AND ARTICLE	YEAGER, GARY WILLIAM
<u>60306017</u>	Not Issued	159	07/17/2001	METHOD FOR PREPARING A THERMOSET COMPOSITION, THERMOSET COMPOSITION PREPARED THEREBY, AND ARTICLES MOLDED FROM THE THERMOSET COMPOSITION	YEAGER, GARY
<u>60262571</u>	Not Issued	159	01/18/2001	POLY(ARYLENE ETHER) - CONTAINING THERMOSET COMPOSITION, METHOD FOR THE PREPARATION THEREOF, AND ARTICLES DERIVED THEREFROM	YEAGER, GARY WILLIAM
<u>60262522</u>	Not Issued	159	01/18/2001	ELECTRICALLY CONDUCTIVE THERMOSET COMPOSITION, METHOD FOR THE PREPARATION THEREOF, AND ARTICLES DERIVED THEREFROM	YEAGER, GARY WILLIAM
<u>60212752</u>	Not Issued	159	06/20/2000	POLY (ARYLENE ETHER) ADHESIVE COMPOSITIONS	YEAGER, GARY W.
<u>60188513</u>	Not Issued	159	03/10/2000	ULTRA WIDEBAND ANTENNA	YEAGER, GARY W.
<u>11022904</u>	Not Issued	019	12/22/2004	TACK FREE COMPOSITIONS USEFUL FOR ELECTRONIC ENCAPSULATION	YEAGER, GARY WILLIAM
<u>11014139</u>	Not Issued	020	12/16/2004	POLYPHENYLENE ETHER - POLYCARBONATE BLOCK	YEAGER, GARY WILLIAM

				COPOLYMERS AND METHODS FOR MAKING THEM	
<u>11014138</u>	Not Issued	020	12/16/2004	CROSS-LINKED POLYIMIDE AND METHOD OF MAKING THEM	YEAGER, GARY WILLIAM
<u>10947265</u>	Not Issued	020	09/23/2004	FLAME-RETARDANT THERMOSET COMPOSITION, METHOD, AND ARTICLE	YEAGER, GARY WILLIAMS
<u>10923518</u>	Not Issued	020	08/20/2004	MOLDING METHOD FOR CURABLE POLY(ARYLENE ETHER) COMPOSITION AND ARTICLE THEREBY	YEAGER, GARY WILLIAM
<u>10783212</u>	Not Issued	030	02/20/2004	FUNCTIONALIZED POLY (ARYLENE ETHER) COMPOSITION AND PROCESS	YEAGER, GARY WILLIAM
<u>10733062</u>	Not Issued	020	12/11/2003	THERMOSET COMPOSITE COMPOSITION, METHOD, AND ARTICLE	YEAGER, GARY WILLIAM
<u>10678471</u>	Not Issued	020	10/03/2003	FLAME-RETARDANT THERMOSET COMPOSITION, METHOD, AND ARTICLE	YEAGER, GARY WILLIAM
<u>10678459</u>	Not Issued	030	10/03/2003	POLY (ARYLENE ETHER) COMPOSITION AND METHOD	YEAGER, GARY WILLIAM
<u>10678252</u>	Not Issued	093	10/03/2003	COMPOSITIONS COMPRISING FUNCTIONALIZED POLYPHENYLENE ETHER RESINS	YEAGER, GARY WILLIAM
<u>10678249</u>	Not Issued	041	10/03/2003	COMPOSITION COMPRISING FUNCTIONALIZED POLY (ARYLENE ETHER) AND ETHYLENE-ALKYL (METH) ACRYLATE COPOLYMER, METHOD FOR THE PREPARATION THEREOF, AND ARTICLES PREPARED THEREFROM	YEAGER, GARY WILLIAM
<u>10678243</u>	Not Issued	071	10/03/2003	CAPPED POLY(ARYLENE ETHER) COMPOSITION AND PROCESS	YEAGER, GARY WILLIAM
<u>10637943</u>	Not Issued	092	08/07/2003	THERMOSET COMPOSITION, METHOD FOR THE PREPARATION THEREOF, AND ARTICLES PREPARED	YEAGER, GARY WILLIAM

				THEREFROM	
<u>10604214</u>	Not Issued	030	07/01/2003	CAPPED POLY(ARYLENE ETHER) COMPOSITION AND METHOD	YEAGER, GARY WILLIAM
<u>10425906</u>	Not Issued	092	04/29/2003	SOLID STATE DEVICE WITH ENCAPSULANT OF CYCLOALIPHATIC EPOXY RESIN, ANHYDRIDE, AND BORON CATALYST	YEAGER, GARY WILLIAM
<u>10355878</u>	<u>6784260</u>	150	01/31/2003	POWDER COATING OF THERMOSETTING RESIN (S), POLYPHENYLENE ETHER (S) AND CURING AGENT(S)	YEAGER, GARY WILLIAM
<u>10250096</u>	<u>6780959</u>	150	06/03/2003	COMPOSITIONS COMPRISING FUNCTIONALIZED POLYPHENYLENE ETHER RESINS	YEAGER, GARY WILLIAM
<u>10248587</u>	<u>6770107</u>	150	01/30/2003	ABRASIVE-FILLED THERMOSET COMPOSITION AND ITS PREPARATION, AND ABRASIVE-FILLED ARTICLES AND THEIR PREPARATION	YEAGER, GARY WILLIAM
<u>10188181</u>	<u>6812276</u>	150	07/02/2002	POLY (ARYLENE ETHER)-CONTAINING THERMOSET COMPOSITION, METHOD FOR THE PREPARATION THEREOF, AND ARTICLES DERIVED THEREFROM	YEAGER, GARY WILLIAM
<u>10119406</u>	Not Issued	071	04/09/2002	THERMOSET COMPOSITION, METHOD, AND ARTICLE	YEAGER, GARY WILLIAM
<u>10063293</u>	Not Issued	160	04/09/2002	THERMOSET COMPOSITION, METHOD, AND ARTICLE	YEAGER, GARY WILLIAM
<u>10063292</u>	Not Issued	093	04/09/2002	THERMOSET COMPOSITION, METHOD, AND ARTICLE	YEAGER, GARY WILLIAM
<u>10063152</u>	<u>6627708</u>	150	03/26/2002	COMPOSITIONS COMPRISING FUNCTIONALIZED POLYPHENYLENE ETHER RESINS	YEAGER, GARY WILLIAM
<u>09943342</u>	<u>6617398</u>	150	08/30/2001	POLY (PHENYLENE ETHER) - POLYVINYL THERMOSETTING RESIN	YEAGER, GARY W.
<u>09935369</u>	<u>6617400</u>	150	08/23/2001	COMPOSITION OF CYCLOALIPHATIC EPOXY RESIN, ANHYDRIDE CURING AGENT AND BORON CATALYST	YEAGER, GARY WILLIAM

<u>09871379</u>	Not Issued	161	05/31/2001	CARBOXY-FUNCTIONALIZED POLYPHENYLENE ETHERS AND BLENDS CONTAINING THEM	YEAGER, GARY WILLIAM
<u>09871378</u>	<u>6552133</u>	150	05/31/2001	METHOD FOR MAKING CARBOXY-FUNCTIONALIZED POLYPHENYLENE ETHERS, AND BLENDS CONTAINING THEM	YEAGER, GARY WILLIAM
<u>09760125</u>	<u>6403229</u>	150	01/16/2001	CYANATE ESTER BASED THERMOSET COMPOSITIONS	YEAGER, GARY WILLIAM
<u>09732699</u>	<u>6433744</u>	150	12/11/2000	WIDEBAND PATCH ANTENNA	YEAGER, GARY WILLIAM
<u>09683887</u>	<u>6770691</u>	150	02/27/2002	CURABLE EPOXY RESIN COMPOSITIONS AND THE CURED RESIDUES THEREOF	YEAGER, GARY W.
<u>09683883</u>	<u>6767639</u>	150	02/27/2002	CURED EPOXY RESIN COMPOSITIONS WITH BROMINATED TRIAZINE FLAME RETARDANTS, AND LAMINATES COMPRISING THEM	YEAGER, GARY W.
<u>09683880</u>	<u>6774160</u>	150	02/27/2002	CURABLE EPOXY RESIN COMPOSITIONS AND THE CURED RESIDUES THEREOF	YEAGER, GARY W.
<u>09683352</u>	<u>6469124</u>	150	12/18/2001	FUNCTIONALIZED POLYPHENYLENE ETHER RESINS AND CURABLE COMPOSITIONS COMPRISING THEM	YEAGER, GARY WILLIAM
<u>09683214</u>	Not Issued	094	12/03/2001	ELECTRICALLY CONDUCTIVE THERMOSET COMPOSITION, METHOD FOR THE PREPARATION THEREOF, AND ARTICLES DERIVED THEREFROM	YEAGER, GARY WILLIAM
<u>09682057</u>	<u>6627704</u>	150	07/16/2001	POLY(ARYLENE ETHER)- CONTAINING THERMOSET COMPOSITION, METHOD FOR THE PREPARATION THEREOF, AND ARTICLES DERIVED THEREFROM	YEAGER, GARY WILLIAM
<u>09681381</u>	<u>6593391</u>	150	03/27/2001	ABRASIVE-FILLED THERMOSET COMPOSITION AND ITS PREPARATION, AND ABRASIVE-FILLED ARTICLES AND THEIR PREPARATION	YEAGER, GARY WILLIAM

09681376	Not Issued	093	03/27/2001	POLY(ARYLENE ETHER)-CONTAINING THERMOSET COMPOSITION IN POWDER FORM, METHOD FOR THE PREPARATION THEREOF, AND ARTICLES DERIVED THEREFROM	YEAGER, GARY WILLIAM
09654830	6507049	150	09/01/2000	ENCAPSULANTS FOR SOLID STATE DEVICES	YEAGER, GARY WILLIAM
09644012	Not Issued	092	08/22/2000	POLY(ARYLENE ETHER) ADHESIVE COMPOSITIONS	YEAGER, GARY WILLIAM
09617969	6576718	150	10/04/2000	POWDER COATING OF THERMOSETTING RESIN(S) AND POLY(POLY(PHENYLENE ETHER(S)))	YEAGER, GARY WILLIAM
09613112	6384176	150	07/10/2000	COMPOSITION AND PROCESS FOR THE MANUFACTURE OF FUNCTIONALIZED POLYPHENYLENE ETHER RESINS	YEAGER, GARY W.
09455070	6339131	150	12/06/1999	SYNTHESIS OF POLY(ARYLENE ETHER)-POLY(ORGANOSILOXANE) COPOLYMERS	YEAGER, GARY W.
09452733	6352782	150	12/01/1999	POLY(PHENYLENE ETHER) - POLYVINYL THERMOSETTING RESIN	YEAGER, GARY W.
07046442	Not Issued	161	05/06/1987	DIGITAL RADIOGRAPHIC IMAGING SYSTEM AND METHOD THEREFOR	YEAGER, GARY W.

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Search Another: Inventor	Last Name	First Name	<input type="button" value="Search"/>
	<input type="text" value="Yeager"/>	<input type="text" value="Gary"/>	

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Day : Friday
Date: 2/11/2005


PALM INTRANET

Time: 14:29:16

Inventor Name Search Result

Your Search was:

Last Name = DUFFEY

First Name = BRYAN

Application#	Patent#	Status	Date Filed	Title	Inventor Name 10
<u>11022904</u>	Not Issued	019	12/22/2004	TACK FREE COMPOSITIONS USEFUL FOR ELECTRONIC ENCAPSULATION	DUFFEY, BRYAN PATRICK
<u>10947265</u>	Not Issued	020	09/23/2004	FLAME-RETARDANT THERMOSET COMPOSITION, METHOD, AND ARTICLE	DUFFEY, BRYAN
<u>10923518</u>	Not Issued	020	08/20/2004	MOLDING METHOD FOR CURABLE POLY(ARYLENE ETHER) COMPOSITION AND ARTICLE THEREBY	DUFFEY, BRYAN
<u>10920744</u>	Not Issued	020	08/18/2004	FUNCTIONALIZED POLY (ARYLENE ETHER) COMPOSITION AND METHOD	DUFFEY, BRYAN
<u>10678471</u>	Not Issued	020	10/03/2003	FLAME-RETARDANT THERMOSET COMPOSITION, METHOD, AND ARTICLE	DUFFEY, BRYAN
<u>10678249</u>	Not Issued	041	10/03/2003	COMPOSITION COMPRISING FUNCTIONALIZED POLY (ARYLENE ETHER) AND ETHYLENE-ALKYL (METH) ACRYLATE COPOLYMER, METHOD FOR THE PREPARATION THEREOF, AND ARTICLES PREPARED THEREFROM	DUFFEY, BRYAN
<u>10376513</u>	6820606	150	02/28/2003	ADJUSTABLE SEAR FOR PAINTBALL GUN	DUFFEY, BRYAN H.
<u>10119406</u>	Not Issued	071	04/09/2002	THERMOSET COMPOSITION, METHOD, AND ARTICLE	DUFFEY, BRYAN
<u>10063293</u>	Not Issued	160	04/09/2002	THERMOSET COMPOSITION, METHOD, AND ARTICLE	DUFFEY, BRYAN
<u>10063292</u>	Not	093	04/09/2002	THERMOSET COMPOSITION,	DUFFEY, BRYAN

	Issued		METHOD, AND ARTICLE	
--	--------	--	---------------------	--

Inventor Search Completed: No Records to Display.

	Last Name	First Name	
Search Another: Inventor	<input type="text" value="Duffey"/>	<input type="text" value="Bryan"/>	<input type="button" value="Search"/>

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0.21

0.21

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COST IN U.S. DOLLARS

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TOTAL

ENTRY

SESSION

FULL ESTIMATED COST

9.26

9.47

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CA INDEXING COPYRIGHT (C) 2005 AMERICAN CHEMICAL SOCIETY (ACS)

=> s polyarylene ether# and ethylene alkyl meth acrylate copolymer#

L1 1 POLYARYLENE ETHER# AND ETHYLENE ALKYL METH ACRYLATE COPOLYMER#

=> d

L1 ANSWER 1 OF 1 USPATFULL on STN

AN 2004:154495 USPATFULL

TI Polyacetal resin composition and process for production thereof

IN Harashina, Hatsuhiko, Fuji, JAPAN

PA Polyplastics Co., Ltd., Osaka, JAPAN (non-U.S. corporation)

PI US 6753363 B1 20040622

WO 2001005888 20010125

AI US 2001-786721 20010308 (9)
WO 2000-JP4778 20000714
PRAI JP 1999-203932 19990716
DT Utility
FS GRANTED
LN.CNT 2649
INCL INCLM: 524/099.000
INCLS: 524/099.000; 524/100.000; 524/127.000; 524/140.000; 524/147.000;
524/153.000; 524/414.000; 523/206.000; 523/207.000; 523/351.000
NCL NCLM: 524/099.000
NCLS: 523/206.000; 523/207.000; 523/351.000; 524/100.000; 524/127.000;
524/140.000; 524/147.000; 524/153.000; 524/414.000
IC [7]
ICM: C08K005-3432
ICS: C08K005-31; C08K005-521; C08K003-02; C08K005-5333
EXF 524/99-100; 524/102; 524/127; 524/140; 524/145; 524/147; 524/153;
524/414; 524/143; 523/206-207; 523/351
CAS INDEXING IS AVAILABLE FOR THIS PATENT.

=> s functionalized polyarylene ether# or functionalized poly arylene ether#
L2 71 FUNCTIONALIZED POLYARYLENE ETHER# OR FUNCTIONALIZED POLY ARYLENE
ETHER#

=> s l2 and (ethylene alkyl or olefin alkyl)
L3 2 L2 AND (ETHYLENE ALKYL OR OLEFIN ALKYL)

=> d l3 1-2

L3 ANSWER 1 OF 2 PCTFULL COPYRIGHT 2005 Univentio on STN
AN 2000034390 PCTFULL ED 20020515
TIEN POLY(ARYLENE ETHER)/POLYETHERIMIDE BLENDS AND METHODS OF MAKING THE SAME
TIFR MELANGES DE POLY(ARYLENE ETHER)/POLYETHERIMIDE ET LEURS PROCEDES DE
FABRICATION
IN BROWN, Sterling, Bruce;
GILES, Brenda, A.;
JIN, Yimin;
NAZARETH, Darryl;
RICE, Steven, Thomas;
PUYENBROEK, Robert;
MCKINLEY, Barbara, Jean
PA GENERAL ELECTRIC COMPANY
LA English
DT Patent
PI WO 2000034390 A1 20000615
DS W: JP SG AT BE CH CY DE DK ES FI FR GB GR IE IT LU MC NL PT
SE
AI WO 1999-US24428 A 19991018
PRAI US 1998-09/208,364 19981210
ICM C08L071-12
ICS C08L079-08

L3 ANSWER 2 OF 2 USPATFULL on STN
AN 2000:174763 USPATFULL
TI Poly(arylene ether)/polyetherimide blends and methods of making the same
IN Brown, Sterling Bruce, Niskayuna, NY, United States
Giles, Brenda A., Mt. Vernon, IN, United States
Jin, Yimin, Newburgh, IN, United States
Nazareth, Darryl, Flanders, NJ, United States
Rice, Steven Thomas, Scotia, NY, United States
Puyenbroek, Robert, Bergen op Zoom, Netherlands
McKinley, Barbara J., Rochester, NY, United States
PA General Electric Company, Pittsfield, MA, United States (U.S.
corporation)
PI US 6166137 20001226
AI US 1998-208364 19981210 (9)
DT Utility
FS Granted

LN.CNT 1230
INCL INCLM: 525/133.000
INCLS: 525/397.000; 525/430.000; 525/436.000; 524/262.000; 524/269.000
NCL NCLM: 525/133.000
NCLS: 524/262.000; 524/269.000; 525/397.000; 525/430.000; 525/436.000
IC [7]
ICM: C08L071-10
ICS: C08L079-08
EXF 525/133; 525/397; 525/430; 525/436; 524/262; 524/269
CAS INDEXING IS AVAILABLE FOR THIS PATENT.

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FILE 'USPAT2' ENTERED AT 14:49:54 ON 11 FEB 2005

CA INDEXING COPYRIGHT (C) 2005 AMERICAN CHEMICAL SOCIETY (ACS)

=> s functionalized polyarylene ether# or functionalized poly arylene ether#

L1 71 FUNCTIONALIZED POLYARYLENE ETHER# OR FUNCTIONALIZED POLY ARYLENE ETHER#

=> s l1 and (ethylene acrylate copolymer# or ethylene methacrylate copolymer#)

L2 0 L1 AND (ETHYLENE ACRYLATE COPOLYMER# OR ETHYLENE METHACRYLATE COPOLYMER#)

=> s l1 and (olefin acrylate copolymer# or olefin methacrylate copolymer#)

L3 0 L1 AND (OLEFIN ACRYLATE COPOLYMER# OR OLEFIN METHACRYLATE COPOLYMER#)

=> s l1 and (acrylate copolymer# or methacrylate copolymer#)

L4 22 L1 AND (ACRYLATE COPOLYMER# OR METHACRYLATE COPOLYMER#)

=> s l4 and flame retardant

L5 5 L4 AND FLAME RETARDANT

=> d l5 1-5

L5 ANSWER 1 OF 5 PCTFULL COPYRIGHT 2005 Univentio on STN

AN 2002057365 PCTFULL ED 20020801 EW 200230

TIEN ELECTRICALLY CONDUCTIVE THERMOSET COMPOSITION, METHOD FOR THE PREPARATION THEREOF, AND ARTICLES DERIVED THEREFROM

TIFR THERMODURCI CONDUCTEUR DE L'ELECTRICITE, SON PROCEDE DE PREPARATION ET ARTICLES EN ETANT FAITS

IN YEAGER, Gary, William, 24 Riverwind Drive, Rexford, NY 12148, US;

CAVAZOS, Manuel, 12902 Route 9W, West Coxsackie, NY 12192, US;

GUO, Hua, 93 Dorchester Avenue, Selkirk, NY 12158, US;

MERFELD, Glen, David, 7-AR Dutch Village, Menands, NY 12204, US;

RUDE, John, 1-8N Park 200 Apartments, Clifton Park, NY 12065, US;

TEUTSCH, Erich, Otto, 488 Summit Road, Pittsfield, MA 01254, US;

ZARNOCH, Kenneth, Paul, 7 Horstman Drive, Scotia, NY 12302, US

PA GENERAL ELECTRIC COMPANY, One River Road, Schenectady, NY 12345, US [US, US]

AG HARRINGTON, Mark, F., Harrington & Smith, LLP, 1809 Black Rock Turnpike, Fairfield, CT 06432-3504, US

LAF English

LA English
DT Patent
PI WO 2002057365 A1 20020725
DS W: AE AG AL AM AT AU AZ BA BB BG BR BY BZ CA CH CN CO CR CU
CZ DE DK DM DZ EC EE ES FI GB GD GE GH GM HR HU ID IL IN
IS JP KE KG KP KR KZ LC LK LR LS LT LU LV MA MD MG MK MN
MW MX MZ NO NZ PL PT RO RU SD SE SG SI SK SL TJ TM TR TT
TZ UA UG UZ VN YU ZA ZW
RW (ARIPO): GH GM KE LS MW MZ SD SL SZ TZ UG ZM ZW
RW (EAPO): AM AZ BY KG KZ MD RU TJ TM
RW (EPO): AT BE CH CY DE DK ES FI FR GB GR IE IT LU MC NL PT SE TR
RW (OAPI): BF BJ CF CG CI CM GA GN GQ GW ML MR NE SN TD TG

AI WO 2001-US48852 A 20011214
PRAI US 2001-60/262,522 20010118
US 2001-60/306,017 20010717
US 2001-09/683,214 20011203
ICM C08L071-12
ICS C08G065-48; C09D171-12; H01B001-00

L5 ANSWER 2 OF 5 PCTFULL COPYRIGHT 2005 Univentio on STN
AN 1999020449 PCTFULL ED 20020515
TIEN INJECTION-MOLDED ARTICLES MADE FROM LONG CHAIN BRANCHED SYNDIOTACTIC
MONOVINYLDENE AROMATIC POLYMERS
TIFR ARTICLES MOULES PAR INJECTION ET FABRIQUES A PARTIR DE POLYMERES
AROMATIQUES DE MONOVINYLDENE, SYNDIOTACTIQUES, RAMIFIES ET A LONGUE
CHAINE
IN MAECKER, Norbert, L.;
HUANG, Yi-Bin;
NICHOLS, Kevin, L.
PA THE DOW CHEMICAL COMPANY

LA English
DT Patent
PI WO 9920449 A1 19990429
DS W: AL AM AT AU AZ BA BB BG BR BY CA CH CN CU CZ DE DK EE ES
FI GB GE GH GM HR HU ID IL IS JP KE KG KP KR KZ LC LK LR
LS LT LU LV MD MG MK MN MW MX NO NZ PL PT RO RU SD SE SG
SI SK SL TJ TM TR TT UA UG UZ VN YU ZW GH GM KE LS MW SD
SZ UG ZW AM AZ BY KG KZ MD RU TJ TM AT BE CH CY DE DK ES
FI FR GB GR IE IT LU MC NL PT SE BF BJ CF CG CI CM GA GN
GW ML MR NE SN TD TG

AI WO 1998-US18666 A 19980904
PRAI US 1997-60/064,749 19971017
ICM B29C045-00
ICS C08L025-08; C08K013-02; B29K025-00

L5 ANSWER 3 OF 5 USPATFULL on STN
AN 2003:140283 USPATFULL
TI Poly (arylene ether)-containing thermoset composition, method for the
preparation thereof, and articles derived therefrom.
IN Yeager, Gary William, Rexford, NY, UNITED STATES
PA General Electric Company (U.S. corporation)
PI US 2003096123 A1 20030522
US 6812276 B2 20041102
AI US 2002-188181 A1 20020702 (10)
RLI Continuation-in-part of Ser. No. US 2001-682057, filed on 16 Jul 2001,
PENDING Continuation-in-part of Ser. No. US 1999-452733, filed on 1 Dec
1999, GRANTED, Pat. No. US 6352782
PRAI US 2001-262571P 20010118 (60)
DT Utility
FS APPLICATION
LN.CNT 2596
INCL INCLM: 428/461.000
NCL NCLM: 524/495.000
NCLS: 524/611.000; 525/391.000; 528/205.000
IC [7]
ICM: B32B015-08
CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L5 ANSWER 4 OF 5 USPATFULL on STN
AN 2002:314552 USPATFULL
TI Electrically conductive thermoset composition, method for the
preparation thereof, and articles derived therefrom
IN Yeager, Gary William, Rexford, NY, UNITED STATES
Cavazos, Manuel, West Coxsackie, NY, UNITED STATES
Guo, Hua, Selkirk, NY, UNITED STATES
Merfeld, Glen David, Loudonville, NY, UNITED STATES
Rude, John, Clifton Park, NY, UNITED STATES
Teutsch, Erich Otto, Richmond, MA, UNITED STATES
Zarnoch, Kenneth Paul, Scotia, NY, UNITED STATES
PI US 2002177027 A1 20021128
AI US 2001-683214 A1 20011203 (9)
PRAI US 2001-262522P 20010118 (60)
US 2001-306017P 20010717 (60)
DT Utility
FS APPLICATION
LN.CNT 2320
INCL INCLM: 429/034.000
INCLS: 252/511.000
NCL NCLM: 429/034.000
NCLS: 252/511.000
IC [7]
ICM: H01B001-06
ICS: H01M002-02
CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L5 ANSWER 5 OF 5 USPAT2 on STN
AN 2003:140283 USPAT2
TI Poly(arylene ether)-containing thermoset composition, method for the
preparation thereof, and articles derived therefrom
IN Yeager, Gary William, Rexford, NY, United States
PA General Electric Company, Pittsfield, MA, United States (U.S.
corporation)
PI US 6812276 B2 20041102
AI US 2002-188181 20020702 (10)
RLI Continuation-in-part of Ser. No. US 2001-682057, filed on 16 Jul 2001,
now patented, Pat. No. US 6627704 Continuation-in-part of Ser. No. US
1999-452733, filed on 1 Dec 1999, now patented, Pat. No. US 6352782
PRAI US 2001-262571P 20010118 (60)
DT Utility
FS GRANTED
LN.CNT 2570
INCL INCLM: 524/495.000
INCLS: 524/611.000; 525/391.000; 528/205.000
NCL NCLM: 524/495.000
NCLS: 524/611.000; 525/391.000; 528/205.000
IC [7]
ICM: C08K003-04
EXF 525/391; 528/205; 524/495; 524/611
CAS INDEXING IS AVAILABLE FOR THIS PATENT.

=> d 14 1-22

L4 ANSWER 1 OF 22 PCTFULL COPYRIGHT 2005 Univentio on STN
AN 2003087223 PCTFULL ED 20031031 EW 200343
TIEN THERMOSET COMPOSITION, METHOD AND ARTICLE
TIFR COMPOSITION THERMODURCISSABLE, PROCEDE ET ARTICLE
IN MERFELD, Glen, David, 25 Old Niskayuna Road, Loudonville, NY 12211, US
PA GENERAL ELECTRIC COMPANY (a New York Corporation), 1 River Road,
Schenectady, NY 12345, US [US, US]
AG WINTER Catherine, J., Patent Counsel, General Electric Company, 3135
easton Turnpike (W3C), Fairfield, CT 06828, US
LAF English
LA English
DT Patent
PI WO 2003087223 A1 20031023

DS W: CN JP SG
 RW (EPO): AT BE BG CH CY CZ DE DK EE ES FI FR GB GR HU IE IT LU MC
 NL PT RO SE SI SK TR
 AI WO 2003-US10523 A 20030407
 PRAI US 2002-10/119,406 20020409
 US 2003-10/248,756 20030214
 ICM C08L071-12
 ICS C08L063-00; C08G065-48

L4 ANSWER 2 OF 22 PCTFULL COPYRIGHT 2005 Univentio on STN
 AN 2002059197 PCTFULL ED 20020809 EW 200231
 TIEN TOUGHENED POLYMER BLENDS WITH IMPROVED SURFACE PROPERTIES
 TIFR MELANGES DE POLYMERES DURCIS PRESENTANT DES PROPRIETES DE SURFACE
 AMELIOREES
 IN BANK, David, H., 2931 Blackhurst Lane, Midland, MI 48642, US [US, US];
 OELBERG, James, D., 2450 West Wheeler Road, Auburn, MI 48611, US [US,
 US];
 NAMHATA, Sarada, P., 2510 Abbott Road, #R-11, Midland, MI 48642, US [US,
 US]
 PA THE DOW CHEMICAL COMPANY, 2030 Dow Center, Midland, MI 48674, US [US,
 US], for all designates States except US;
 BANK, David, H., 2931 Blackhurst Lane, Midland, MI 48642, US [US, US],
 for US only;
 OELBERG, James, D., 2450 West Wheeler Road, Auburn, MI 48611, US [US,
 US], for US only;
 NAMHATA, Sarada, P., 2510 Abbott Road, #R-11, Midland, MI 48642, US [US,
 US], for US only
 AG DELINE, Douglas, N., The Dow Chemical Company, Intellectual Property,
 P.O. Box 1967, Midland, MI 48641-1967, US
 LAF English
 LA English
 DT Patent
 PI WO 2002059197 A2 20020801
 DS W: AE AG AL AM AT AU AZ BA BB BG BR BY BZ CA CH CN CO CR CZ
 DE DK DM DZ EC EE ES FI GB GD GE GH GM HR HU ID IL IN IS
 JP KE KG KR KZ LC LK LR LS LT LU LV MA MD MG MK MN MW MX
 MZ NO NZ PL PT RO RU SD SE SG SI SK SL TJ TM TR TT TZ UA
 UG US UZ YU ZA ZW
 RW (ARIPO): GH GM KE LS MW MZ SD SL SZ TZ UG ZM ZW
 RW (EAPO): AM AZ BY KG KZ MD RU TJ TM
 RW (EPO): AT BE CH CY DE DK ES FI FR GB GR IE IT LU MC NL PT SE TR
 RW (OAPI): BF BJ CF CG CI CM GA GN GQ GW ML MR NE SN TD TG

AI WO 2001-US46503 A 20011203
 PRAI US 2001-60/263,954 20010124
 ICM C08L025-00

L4 ANSWER 3 OF 22 PCTFULL COPYRIGHT 2005 Univentio on STN
 AN 2002057365 PCTFULL ED 20020801 EW 200230
 TIEN ELECTRICALLY CONDUCTIVE THERMOSET COMPOSITION, METHOD FOR THE
 PREPARATION THEREOF, AND ARTICLES DERIVED THEREFROM
 TIFR THERMODURCI CONDUCTEUR DE L'ELECTRICITE, SON PROCEDE DE PREPARATION ET
 ARTICLES EN ETANT FAITS
 IN YEAGER, Gary, William, 24 Riverwind Drive, Rexford, NY 12148, US;
 CAVAZOS, Manuel, 12902 Route 9W, West Coxsackie, NY 12192, US;
 GUO, Hua, 93 Dorchester Avenue, Selkirk, NY 12158, US;
 MERFELD, Glen, David, 7-AR Dutch Village, Menands, NY 12204, US;
 RUDE, John, 1-8N Park 200 Apartments, Clifton Park, NY 12065, US;
 TEUTSCH, Erich, Otto, 488 Summit Road, Pittsfield, MA 01254, US;
 ZARNOCH, Kenneth, Paul, 7 Horstman Drive, Scotia, NY 12302, US
 PA GENERAL ELECTRIC COMPANY, One River Road, Schenectady, NY 12345, US [US,
 US]
 AG HARRINGTON, Mark, F., Harrington & Smith, LLP, 1809 Black Rock Turnpike,
 Fairfield, CT 06432-3504, US
 LAF English
 LA English
 DT Patent
 PI WO 2002057365 A1 20020725
 DS W: AE AG AL AM AT AU AZ BA BB BG BR BY BZ CA CH CN CO CR CU

CZ DE DK DM DZ EC EE ES FI GB GD GE GH GM HR HU ID IL IN
IS JP KE KG KP KR KZ LC LK LR LS LT LU LV MA MD MG MK MN
MW MX MZ NO NZ PL PT RO RU SD SE SG SI SK SL TJ TM TR TT
TZ UA UG UZ VN YU ZA ZW

RW (ARIPO): GH GM KE LS MW MZ SD SL SZ TZ UG ZM ZW
RW (EAPO): AM AZ BY KG KZ MD RU TJ TM
RW (EPO): AT BE CH CY DE DK ES FI FR GB GR IE IT LU MC NL PT SE TR
RW (OAPI): BF BJ CF CG CI CM GA GN GQ GW ML MR NE SN TD TG

AI WO 2001-US48852 A 20011214
PRAI US 2001-60/262,522 20010118
US 2001-60/306,017 20010717
US 2001-09/683,214 20011203
ICM C08L071-12
ICS C08G065-48; C09D171-12; H01B001-00

L4 ANSWER 4 OF 22 PCTFULL COPYRIGHT 2005 Univentio on STN
AN 2000047669 PCTFULL ED 20020515
TIEN FIBER REINFORCED SYNDIOTACTIC MONOVINYLDENE AROMATIC POLYMER
COMPOSITIONS HAVING HIGH GLOSS
TIFR COMPOSITIONS POLYMERES AROMATIQUES DE MONOVINYLDENE SYNDIOTACTIQUES
RENFORCEES EN FIBRES, POSSEDANT UN BRILLANT ELEVE

IN NICHOLS, Kevin, L.;
BANK, David, H.

PA THE DOW CHEMICAL COMPANY

LA English

DT Patent

PI WO 2000047669 A1 20000817

DS W: AE AL AM AT AU AZ BA BB BG BR BY CA CH CN CR CU CZ DE DK
DM EE ES FI GB GD GE GH GM HR HU ID IL IN IS JP KE KG KP
KR KZ LC LK LR LS LT LU LV MA MD MG MK MN MW MX NO NZ PL
PT RO RU SD SE SG SI SK SL TJ TM TR TT TZ UA UG UZ VN YU
ZA ZW GH GM KE LS MW SD SL SZ TZ UG ZW AM AZ BY KG KZ MD
RU TJ TM AT BE CH CY DE DK ES FI FR GB GR IE IT LU MC NL
PT SE BF BJ CF CG CI CM GA GN GW ML MR NE SN TD TG

AI WO 1999-US27896 A 19991124
PRAI US 1999-60/119,233 19990209
ICM C08L025-06
ICS C08K013-04; C08K013-04; C08K007-02; C08K003-00; C08L025-06; C08L023-08

L4 ANSWER 5 OF 22 PCTFULL COPYRIGHT 2005 Univentio on STN
AN 1999020449 PCTFULL ED 20020515
TIEN INJECTION-MOLDED ARTICLES MADE FROM LONG CHAIN BRANCHED SYNDIOTACTIC
MONOVINYLDENE AROMATIC POLYMERS
TIFR ARTICLES MOULES PAR INJECTION ET FABRIQUES A PARTIR DE POLYMERES
AROMATIQUES DE MONOVINYLDENE, SYNDIOTACTIQUES, RAMIFIES ET A LONGUE
CHAINE

IN MAECKER, Norbert, L.;
HUANG, Yi-Bin;

NICHOLS, Kevin, L.

PA THE DOW CHEMICAL COMPANY

LA English

DT Patent

PI WO 9920449 A1 19990429

DS W: AL AM AT AU AZ BA BB BG BR BY CA CH CN CU CZ DE DK EE ES
FI GB GE GH GM HR HU ID IL IS JP KE KG KP KR KZ LC LK LR
LS LT LU LV MD MG MK MN MW MX NO NZ PL PT RO RU SD SE SG
SI SK SL TJ TM TR TT UA UG UZ VN YU ZW GH GM KE LS MW SD
SZ UG ZW AM AZ BY KG KZ MD RU TJ TM AT BE CH CY DE DK ES
FI FR GB GR IE IT LU MC NL PT SE BF BJ CF CG CI CM GA GN
GW ML MR NE SN TD TG

AI WO 1998-US18666 A 19980904
PRAI US 1997-60/064,749 19971017
ICM B29C045-00
ICS C08L025-08; C08K013-02; B29K025-00

L4 ANSWER 6 OF 22 PCTFULL COPYRIGHT 2005 Univentio on STN
AN 1999016825 PCTFULL ED 20020515
TIEN MOLDING COMPOSITIONS CONTAINING SYNDIOTACTIC MONOVINYLDENE AROMATIC

POLYMER
 TIFR COMPOSITION A MOULER RENFERMANT UN POLYMERE AROMATIQUE DE MONOVINYLDENE
 SYNDIOTACTIQUE
 IN NICHOLS, Kevin, L.;
 WARAKOMSKI, John, M.;
 BANK, David, H.;
 DIEHL, Charles, F.
 PA THE DOW CHEMICAL COMPANY
 LA English
 DT Patent
 PI WO 9916825 A1 19990408
 DS W: AL AM AT AU AZ BA BB BG BR BY CA CH CN CU CZ DE DK EE ES
 FI GB GE GH GM HR HU ID IL IS JP KE KG KP KR KZ LC LK LR
 LS LT LU LV MD MG MK MN MW MX NO NZ PL PT RO RU SD SE SG
 SI SK SL TJ TM TR TT UA UG UZ VN YU ZW GH GM KE LS MW SD
 SZ UG ZW AM AZ BY KG KZ MD RU TJ TM AT BE CH CY DE DK ES
 FI FR GB GR IE IT LU MC NL PT SE BF BJ CF CG CI CM GA GN
 GW ML MR NE SN TD TG
 AI WO 1998-US18048 A 19980831
 PRAI US 1997-60/060,299 19970929
 ICM C08L025-06
 ICS C08L025-06; C08L023-08; C08L025-06; C08L025-08
 L4 ANSWER 7 OF 22 PCTFULL COPYRIGHT 2005 Univentio on STN
 AN 1999014273 PCTFULL ED 20020515
 TIEN TOUGHENED POLYMER BLENDS
 TIFR MELANGES DE POLYMERES DURCIS
 IN WARAKOMSKI, John, M.;
 BANK, David, H.;
 HO, Thoi, H.
 PA THE DOW CHEMICAL COMPANY
 LA English
 DT Patent
 PI WO 9914273 A1 19990325
 DS W: AL AM AT AU AZ BA BB BG BR BY CA CH CN CU CZ DE DK EE ES
 FI GB GE GH GM HR HU ID IL IS JP KE KG KP KR KZ LC LK LR
 LS LT LU LV MD MG MK MN MW MX NO NZ PL PT RO RU SD SE SG
 SI SK SL TJ TM TR TT UA UG UZ VN YU ZW GH GM KE LS MW SD
 SZ UG ZW AM AZ BY KG KZ MD RU TJ TM AT BE CH CY DE DK ES
 FI FR GB GR IE IT LU MC NL PT SE BF BJ CF CG CI CM GA GN
 GW ML MR NE SN TD TG
 AI WO 1998-US17889 A 19980828
 PRAI US 1997-60/058,713 19970912
 ICM C08L077-00
 ICS C08L025-06; C08L071-12
 L4 ANSWER 8 OF 22 PCTFULL COPYRIGHT 2005 Univentio on STN
 AN 1997032928 PCTFULL ED 20020514
 TIEN MOLDING COMPOSITION CONTAINING SYNDIOTACTIC VINYLAROMATIC POLYMER
 TIFR COMPOSITION DE MOULAGE CONTENANT UN POLYMERE VINYLAROMATIQUE
 SYNDIOTACTIQUE
 IN BANK, David, H.;
 WU, Shaofu;
 WARAKOMSKI, John, M.;
 SEHANOBISH, Kalyan
 PA THE DOW CHEMICAL COMPANY
 LA English
 DT Patent
 PI WO 9732928 A1 19970912
 DS W: CA CN JP KR MX SG AT BE CH DE DK ES FI FR GB GR IE IT LU
 MC NL PT SE
 AI WO 1997-US649 A 19970116
 PRAI US 1996-60/012,882 19960305
 ICM C08L025-06
 ICS C08L025:06; C08L023:16; C08L053:02
 L4 ANSWER 9 OF 22 PCTFULL COPYRIGHT 2005 Univentio on STN
 AN 1994024206 PCTFULL ED 20020513

TIEN IMPACT MODIFIED SYNDIOTACTIC VINYLAROMATIC POLYMERS
TIFR POLYMERES VINYLAROMATIQUES SYNDIOTACTIQUES MODIFIES PAR IMPACT
IN WESSEL, Thomas, E.;
HUANG, Yi-Bin;
THILL, Bruce, P.
PA THE DOW CHEMICAL COMPANY
LA English
DT Patent
PI WO 9424206 A1 19941027
DS W: CA JP KR AT BE CH DE DK ES FR GB GR IE IT LU MC NL PT SE
AI WO 1994-US790 A 19940121
PRAI US 1993-8/050,949 19930421
ICM C08L025-06
ICS C08L071:12; C08L053:02

L4 ANSWER 10 OF 22 USPATFULL on STN
AN 2004:139574 USPATFULL
TI CAPPED POLY(ARYLENE ETHER) COMPOSITION AND METHOD
IN Yeager, Gary William, 24 Riverwind Drive, Rexford, NY, UNITED STATES
12148
Guo, Hua, 93 Dorchester Avenue, Selkirk, NY, UNITED STATES 12158
Lin, Zhiqing, 21 Latham Village Ln, #8, Latham, NY, UNITED STATES 12110
Murtuza, Shahid, 1980 Western Avenue, Apt. 134, Albany, NY, UNITED
STATES 12203
PA GENERAL ELECTRIC COMPANY, Schenectady, NY, UNITED STATES (U.S.
corporation)
PI US 2004106750 A1 20040603
AI US 2003-604214 A1 20030701 (10)
RLI Continuation-in-part of Ser. No. US 2001-683214, filed on 3 Dec 2001,
PENDING
PRAI US 2001-262522P 20010118 (60)
US 2001-306017P 20010717 (60)
DT Utility
FS APPLICATION
LN.CNT 1365
INCL INCLM: 525/502.000
NCL NCLM: 525/502.000
IC [7]
ICM: C08G008-30
ICS: C08F283-00

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L4 ANSWER 11 OF 22 USPATFULL on STN
AN 2004:70854 USPATFULL
TI Toughened polymer blends with improved surface properties
IN Bank, David H, Midland, MI, UNITED STATES
Oelberg, James D., Auburn, MI, UNITED STATES
Namhata, Sarada P., Midland, MI, UNITED STATES
PI US 2004054082 A1 20040318
AI US 2003-451981 A1 20030625 (10)
WO 2001-US46503 20011203
DT Utility
FS APPLICATION
LN.CNT 882
INCL INCLM: 525/123.000
NCL NCLM: 525/123.000
IC [7]
ICM: C08L075-00

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L4 ANSWER 12 OF 22 USPATFULL on STN
AN 2003:312854 USPATFULL
TI THERMOSET COMPOSITION, METHOD, AND ARTICLE
IN Merfeld, Glen, 25 Old Niskayuna Road, Loudonville, NY, UNITED STATES
12211
PI US 2003220460 A1 20031127
AI US 2003-248756 A1 20030214 (10)
RLI Continuation-in-part of Ser. No. US 2002-119406, filed on 9 Apr 2002,

PENDING
DT Utility
FS APPLICATION
LN.CNT 2609
INCL INCLM: 526/347.200
INCLS: 585/428.000
NCL NCLM: 526/347.200
NCLS: 585/428.000
IC [7]
ICM: C08F112-08
CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L4 ANSWER 13 OF 22 USPATFULL on STN
AN 2003:306155 USPATFULL
TI Thermoset composition, method, and article
IN Yeager, Gary William, Rexford, NY, UNITED STATES
Merfeld, Glen David, Loudonville, NY, UNITED STATES
Duffey, Bryan, Ballston Spa, NY, UNITED STATES
PI US 2003215588 A1 20031120
AI US 2002-119406 A1 20020409 (10)
DT Utility
FS APPLICATION
LN.CNT 2559
INCL INCLM: 428/035.700
NCL NCLM: 428/035.700
IC [7]
ICM: B32B001-02
CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L4 ANSWER 14 OF 22 USPATFULL on STN
AN 2003:140283 USPATFULL
TI Poly (arylene ether)-containing thermoset composition, method for the
preparation thereof, and articles derived therefrom
IN Yeager, Gary William, Rexford, NY, UNITED STATES
PA General Electric Company (U.S. corporation)
PI US 2003096123 A1 20030522
US 6812276 B2 20041102
AI US 2002-188181 A1 20020702 (10)
RLI Continuation-in-part of Ser. No. US 2001-682057, filed on 16 Jul 2001,
PENDING Continuation-in-part of Ser. No. US 1999-452733, filed on 1 Dec
1999, GRANTED, Pat. No. US 6352782
PRAI US 2001-262571P 20010118 (60)
DT Utility
FS APPLICATION
LN.CNT 2596
INCL INCLM: 428/461.000
NCL NCLM: 524/495.000
NCLS: 524/611.000; 525/391.000; 528/205.000
IC [7]
ICM: B32B015-08
CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L4 ANSWER 15 OF 22 USPATFULL on STN
AN 2002:314552 USPATFULL
TI Electrically conductive thermoset composition, method for the
preparation thereof, and articles derived therefrom
IN Yeager, Gary William, Rexford, NY, UNITED STATES
Cavazos, Manuel, West Coxsackie, NY, UNITED STATES
Guo, Hua, Selkirk, NY, UNITED STATES
Merfeld, Glen David, Loudonville, NY, UNITED STATES
Rude, John, Clifton Park, NY, UNITED STATES
Teutsch, Erich Otto, Richmond, MA, UNITED STATES
Zarnoch, Kenneth Paul, Scotia, NY, UNITED STATES
PI US 2002177027 A1 20021128
AI US 2001-683214 A1 20011203 (9)
PRAI US 2001-262522P 20010118 (60)
US 2001-306017P 20010717 (60)
DT Utility

FS APPLICATION
LN.CNT 2320
INCL INCLM: 429/034.000
INCLS: 252/511.000
NCL NCLM: 429/034.000
NCLS: 252/511.000
IC [7]
ICM: H01B001-06
ICS: H01M002-02

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L4 ANSWER 16 OF 22 USPATFULL on STN
AN 2002:301709 USPATFULL
TI Thermoset composition, method, and article
IN Merfeld, Glen David, Loudonville, NY, UNITED STATES
Yeager, Gary William, Rexford, NY, UNITED STATES
Colborn, Robert Edgar, Niskayuna, NY, UNITED STATES
Duffey, Bryan, Ballston Spa, NY, UNITED STATES
PI US 2002169256 A1 20021114
AI US 2002-63292 A1 20020409 (10)
RLI Continuation-in-part of Ser. No. US 2001-682057, filed on 16 Jul 2001,
PENDING Continuation-in-part of Ser. No. US 1999-452733, filed on 1 Dec
1999, GRANTED, Pat. No. US 6352782
DT Utility
FS APPLICATION
LN.CNT 2659
INCL INCLM: 525/258.000
NCL NCLM: 525/258.000
IC [7]
ICM: C08F004-00

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L4 ANSWER 17 OF 22 USPATFULL on STN
AN 2001:79241 USPATFULL
TI Molding composition containing syndiotactic vinylaromatic polymer
IN Bank, David H., Midland, MI, United States
Warakomski, John M., Midland, MI, United States
Wu, Shaofu, Missouri City, TX, United States
Sehanobish, Kalyan, Friendwood, TX, United States
PA The Dow Chemical Company, Midland, MI, United States (U.S. corporation)
PI US 6239217 B1 20010529
AI US 1999-400567 19990921 (9)
RLI Continuation of Ser. No. US 1997-904374, filed on 1 Aug 1997, now
abandoned Continuation of Ser. No. US 1996-611292, filed on 5 Mar 1996,
now abandoned
PRAI US 1996-12882P 19960305 (60)
DT Utility
FS Granted
LN.CNT 866
INCL INCLM: 525/089.000
INCLS: 525/098.000; 525/099.000; 524/505.000
NCL NCLM: 525/089.000
NCLS: 524/505.000; 525/098.000; 525/099.000
IC [7]
ICM: C08L053-00
ICS: C08L053-02

EXF 525/98; 525/99; 525/89; 524/505

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L4 ANSWER 18 OF 22 USPATFULL on STN
AN 2001:36564 USPATFULL
TI Imaging members containing arylene ether alcohol polymers
IN Fuller, Timothy J., Pittsford, NY, United States
Yanus, John F., Webster, NY, United States
Pai, Damodar M., Fairport, NY, United States
Silvestri, Markus R., Fairport, NY, United States
Narang, Ram S., Macedon, NY, United States
Limburg, William W., Penfield, NY, United States

Renfer, Dale S., Webster, NY, United States
PA Xerox Corporation, Stamford, CT, United States (U.S. corporation)
PI US 6200715 B1 20010313
AI US 1999-363218 19990729 (9)
RLI Continuation-in-part of Ser. No. US 1999-326170, filed on 4 Jun 1999
DT Utility
FS Granted
LN.CNT 2245
INCL INCLM: 430/059.600
INCLS: 430/096.000
NCL NCLM: 430/059.600
NCLS: 430/096.000
IC [7]
ICM: G03G005-05
EXF 430/59.6; 430/96; 430/58.7
CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L4 ANSWER 19 OF 22 USPATFULL on STN
AN 2000:61688 USPATFULL
TI Molding compositions containing syndiotactic monovinylidene aromatic polymer
IN Nichols, Kevin L., Midland, MI, United States
Warakomski, John M., Midland, MI, United States
Bank, David H., Midland, MI, United States
Diehl, Charles F., Lake Jackson, TX, United States
PA The Dow Chemical Company, Midland, MI, United States (U.S. corporation)
PI US 6063872 20000516
AI US 1998-146176 19980903 (9)
PRAI US 1997-60299P 19970929 (60)
DT Utility
FS Granted
LN.CNT 979
INCL INCLM: 525/241.000
INCLS: 525/240.000; 525/098.000; 525/185.000; 524/515.000; 524/528.000;
524/370.000
NCL NCLM: 525/241.000
NCLS: 524/370.000; 524/515.000; 524/528.000; 525/098.000; 525/185.000;
525/240.000
IC [7]
ICM: C08L025-04
ICS: C08L025-06
EXF 525/240; 525/241; 525/98; 525/185; 524/515; 524/528; 524/370
CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L4 ANSWER 20 OF 22 USPATFULL on STN
AN 1999:151346 USPATFULL
TI Toughened polymer blends
IN Warakomski, John M., Midland, MI, United States
Bank, David H., Midland, MI, United States
Ho, Thoi H., Lake Jackson, TX, United States
PA The Dow Chemical Company, Midland, MI, United States (U.S. corporation)
PI US 5990244 19991123
AI US 1998-145044 19980901 (9)
PRAI US 1997-58713P 19970912 (60)
DT Utility
FS Granted
LN.CNT 823
INCL INCLM: 525/179.000
INCLS: 525/092.000
NCL NCLM: 525/179.000
NCLS: 525/092.000B
IC [6]
ICM: C08F008-30
EXF 525/179
CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L4 ANSWER 21 OF 22 USPATFULL on STN
AN 95:16052 USPATFULL

TI Impact modified syndiotactic vinyl aromatic polymers
IN Wessel, Thomas E., Midland, MI, United States
Thill, Bruce P., Midland, MI, United States
Huang, Yi-Bin, Midland, MI, United States
PA The Dow Chemical Company, Midland, MI, United States (U.S. corporation)
PI US 5391603 19950221
AI US 1993-50949 19930421 (8)
RLI Continuation-in-part of Ser. No. US 1992-848602, filed on 9 Mar 1992,
now abandoned
DT Utility
FS Granted
LN.CNT 394
INCL INCLM: 524/396.000
INCLS: 525/068.000; 525/098.000; 524/399.000; 524/494.000
NCL NCLM: 524/396.000
NCLS: 524/399.000; 524/494.000; 525/068.000; 525/098.000
IC [6]
ICM: C08K005-09
ICS: C08L025-10
EXF 524/494; 524/399; 524/396; 526/346; 526/347.2; 525/68; 525/98
CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L4 ANSWER 22 OF 22 USPAT2 on STN
AN 2003:140283 USPAT2
TI Poly(arylene ether)-containing thermoset composition, method for the
preparation thereof, and articles derived therefrom
IN Yeager, Gary William, Rexford, NY, United States
PA General Electric Company, Pittsfield, MA, United States (U.S.
corporation)
PI US 6812276 B2 20041102
AI US 2002-188181 20020702 (10)
RLI Continuation-in-part of Ser. No. US 2001-682057, filed on 16 Jul 2001,
now patented, Pat. No. US 6627704 Continuation-in-part of Ser. No. US
1999-452733, filed on 1 Dec 1999, now patented, Pat. No. US 6352782
PRAI US 2001-262571P 20010118 (60)
DT Utility
FS GRANTED
LN.CNT 2570
INCL INCLM: 524/495.000
INCLS: 524/611.000; 525/391.000; 528/205.000
NCL NCLM: 524/495.000
NCLS: 524/611.000; 525/391.000; 528/205.000
IC [7]
ICM: C08K003-04
EXF 525/391; 528/205; 524/495; 524/611
CAS INDEXING IS AVAILABLE FOR THIS PATENT.

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